Automotive Wireless Connectivity Solutions





WiLink™ 8Q Solutions - Scalable Wi-Fi®, Blutetooth® and GNSS

The Texas Instruments WiLink™ 8Q product family brings high performance Wi-Fi, *Bluetooth*® and GNSS positioning solutions to Infotainment systems. The solutions enable close integration with mobile handsets and high-speed data traffic to multiple devices in parallel. The WiLink 8Q family has a scalable and flexible combo chip architecture where the pin-to-pin compatible devices enable hardware and software reuse across platforms. It offers the lowest power and best-in-class RF performance and co-existence.

WiLink™ 8Q Solutions 5GHz WLAN Front 5GHz End SDIO 2.4GHz WLAN Front 2.4GHz End 2.4GHz Front Fnd Bluetooth® 2.4GHz **UART GPS GLONASS**

WiLink™ 8Q Solutions

Available technology options	WL187xQ	WL183xQ
Dual-band 2x2 MIMO mobile	WL1877Q	WL1837Q
Wi-Fi 802.11 a/b/g/n	WL1873Q	WL1833Q
Wi-Fi 802.11 b/g/n	WL1871Q	WL1831Q
Wi-Fi SS 40MHz (HT40)	•	•
GNSS	•	
Bluetooth® 4.1 (including BLE)	•	•

Kev Features

- Integrated solution for Wi-Fi, Bluetooth® and GNSS
- Qualified following AEC-Q100 guidelines for automotive
 - Bluetooth
 - Bluetooth 4.1, including Bluetooth low energy
 - Best-in-class sensitivity
 - o On-chip mSBC codec
 - Shared UART for Bluetooth, GNSS control
 - PCM for audio
- Wi-Fi
 - IEEE 802.11a/b/g/n
 - Station / Access Point / Wi-Fi Direct
 - Multi-channel / Multi-role
 - Wi-Fi Protected Access 2 (WPA2) and Setup (WPS)
 - 100Mbps throughput
 - Wi-Fi Miracast™ ready
 - SDIO interface
- Location
 - · Autonomous and Assisted GNSS
 - Supporting four satellite systems in parallel: GPS, Glonass, QZSS and SBAS
 - · Short TTFF, fast cold start
 - High tracking sensitivity
 - Sensors blending
 - Integrated LNA, support for external LNA / Active antenna
 - On-chip Position Engine
- Leading co-ex performance through advanced techniques
- Operating temp. -40 to +85°C



www.ti.com/wilink8q 2014

TI Worldwide Technical Support

For further inquiries on automotive connectivity, please contact a TI global sales office or submit an email inquiry to wilink8q@ti.com.

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Note: The European Free Call (Toll Free) number is not active in all countries. If you have technical difficulty calling the free call number, please use the international number above.

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Domestic Toll-Free Number

Note: Toll-free numbers do not support mobile and IP phones.

Australia 1-800-999-084
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Hong Kong 800-96-5941
India 1-800-425-7888

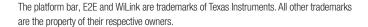
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